

FDPF680N10T-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY			
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	
100	0.034 at V _{GS} = 10 V	50 ^a	

FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

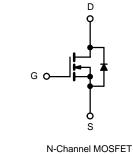
APPLICATIONS

• Isolated DC/DC Converters





GDS



ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	N/		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C		50 ^a		
	T _C = 125 °C	– I _D –	28 ^a	٨	
Pulsed Drain Current		I _{DM}	120	A	
Avalanche Current	L = 0.1 mH	I _{AS}	31		
Single Pulse Avalanche Energy ^b	L = 0.1 mm	E _{AS}	61	mJ	
	T _C = 25 °C	D	360 ^c		
Maximum Power Dissipation ^b	T _A = 25 °C ^d		3.70	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4	0/11	

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•					
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	100			v
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.5		2.5	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μΑ
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			A
		V _{GS} = 10 V, I _D = 30 A		0.034		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.063		Ω
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.084		
Forward Transconductancea	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b						
Input Capacitance	C _{iss}			5100		
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		480		pF
Reverse Transfer Capacitance	C _{rss}			210		
Total Gate Charge ^c	Qg			90	130	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 65 A		23		nC
Gate-Drain Charge ^c	Q _{gd}			34		
Gate Resistance	Rg		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			24	35	
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω		220	330	ns
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong 65$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 2.5 Ω		45	70	115
Fall Time ^c	t _f			200	300	
Source-Drain Diode Ratings and Cha	aracteristics 7	$C = 25 \ ^{\circ}C^{b}$				
Continuous Current	ا _S			50		^
Pulsed Current	I _{SM}			120		A
Forward Voltage ^a	V _{SD}	$I_{F} = 65 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/µs		8	12	A
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC

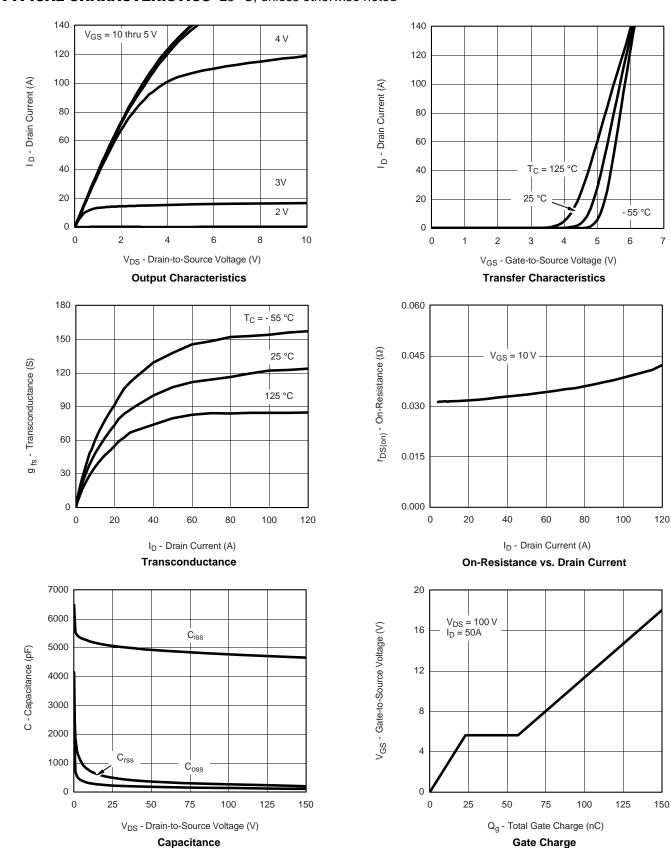
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

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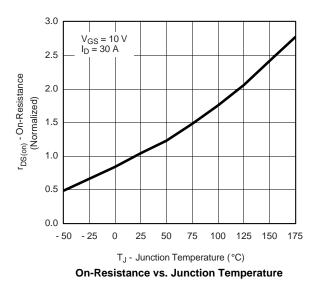


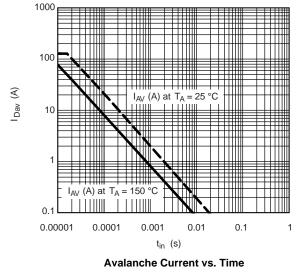


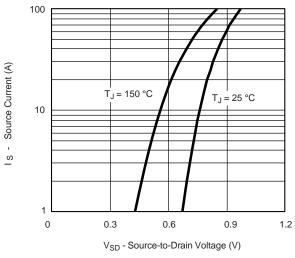
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



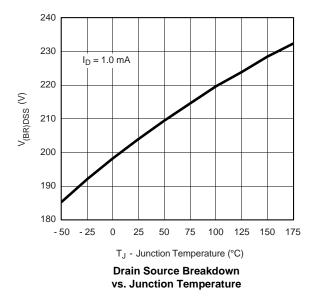
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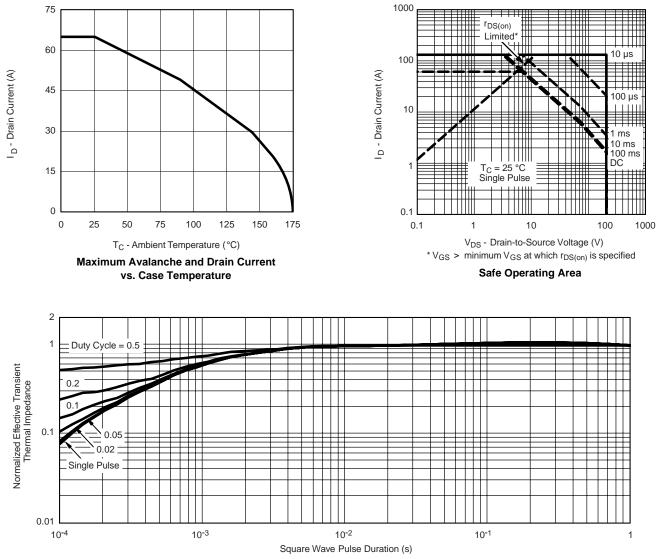
Source-Drain Diode Forward Voltage



FDPF680N10T-VB



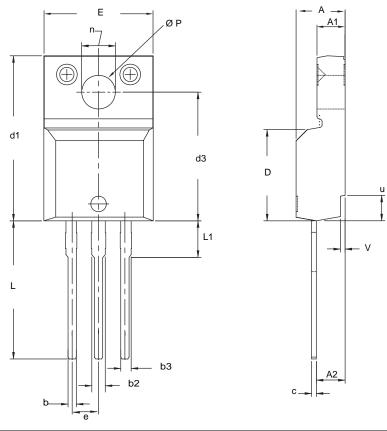
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)



MIN. 4.570 2.570 2.510 0.622 1.229 1.229 0.440 8.650 15.88	MAX. 4.830 2.830 2.850 0.890 1.400 0.629 9.800	MIN. 0.180 0.101 0.099 0.024 0.048 0.048 0.017 0.341	MAX. 0.190 0.111 0.112 0.035 0.055 0.055 0.055 0.025 0.386
2.570 2.510 0.622 1.229 1.229 0.440 8.650	2.830 2.850 0.890 1.400 1.400 0.629 9.800	0.101 0.099 0.024 0.048 0.048 0.048	0.111 0.112 0.035 0.055 0.055 0.055 0.025
2.510 0.622 1.229 1.229 0.440 8.650	2.850 0.890 1.400 1.400 0.629 9.800	0.099 0.024 0.048 0.048 0.017	0.112 0.035 0.055 0.055 0.025
0.622 1.229 1.229 0.440 8.650	0.890 1.400 1.400 0.629 9.800	0.024 0.048 0.048 0.017	0.035 0.055 0.055 0.025
1.229 1.229 0.440 8.650	1.400 1.400 0.629 9.800	0.048 0.048 0.017	0.055 0.055 0.025
1.229 0.440 8.650	1.400 0.629 9.800	0.048 0.017	0.055 0.025
0.440 8.650	0.629 9.800	0.017	0.025
8.650	9.800		
		0.341	0.386
15.88	16 100		0.000
	16.120	0.622	0.635
12.300	12.920	0.484	0.509
10.360	10.630	0.408	0.419
2.54 BSC		0.100	BSC
13.200	13.730	0.520	0.541
3.100	3.500	0.122	0.138
6.050	6.150	0.238	0.242
3.050	3.450	0.120	0.136
2.400	2.500	0.094	0.098
0.400	0.500	0.016	0.020
	10.360 2.54 13.200 3.100 6.050 3.050 2.400	10.360 10.630 2.54 BSC 13.730 3.100 3.500 6.050 6.150 3.050 3.450 2.400 2.500	10.360 10.630 0.408 2.54 BSC 0.100 13.200 13.730 0.520 3.100 3.500 0.122 6.050 6.150 0.238 3.050 3.450 0.120 2.400 2.500 0.094

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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